

2002年12月25日 12時44分

日本代理人申請

This copy of the declaration is intended for the attached application submitted herewith. See the attached ADS sheet for updated information

COPY

**DECLARATION AND POWER OF
ATTORNEY FOR UTILITY OR DESIGN
PATENT APPLICATION
(37 C.F.R. 1.63)**

Declaration Submitted With Initial Filing

Attorney Docket No.	
First Named Inventor	ISAQ OCHIAI
COMPLETE IF KNOWN	
Application Number	10/291,815
Filing Date	November 12, 2002
Group Art Unit	
Examiner Name	

As a below named inventor, I hereby declare that:

My residence, mailing address, and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled **LEAD FRAME, RESIN SEALING MOLD, AND METHOD FOR MANUFACTURING A SEMICONDUCTOR DEVICE USING THE SAME**, the specification of which was filed on November 12, 2002 under U.S. Serial No. 10/291,815.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims as amended by any amendment specifically referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56, including for continuation-in-part applications, material information which became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.

I hereby claim foreign priority benefits under 35 U.S.C. 119(a)-(d) or 365(b) of any foreign application(s) for patent or inventor's certificate, or 365(a) of any PCT international application which designated at least one country other than the United States of America, listed below and have also identified below, by checking the box, any foreign application for patent or inventor's certificate, or any PCT international application having a filing date before that of the application or which priority is claimed.

Prior Foreign Application Numbers	Country	Foreign Filing Date (MM/DD/YYYY)	Priority Claimed	Certified Copies Attached?
2001-346408	JAPAN	November 12, 2001	YES	NO
2002-020296	JAPAN	January 29, 2002	YES	NO

I hereby claim the benefit under 35 U.S.C. 119(e) of any United States provisional application(s) listed below.

Application Number(s)	Filing Date (MM/DD/YYYY)

I or we hereby appoint the registered practitioner(s) associated with Customer No. 6449 to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith. Direct all correspondence to Customer Number 6449.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment or both, under 18 U.S.C. 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

NAME OF SOLE OR FIRST INVENTOR:		<input type="checkbox"/> A petition has been filed for this unsigned inventor	
Given Name (first and middle [if any]) Isao		Family Name or Surname Ochiai	
Inventor's Signature <i>Isao Ochiai</i>		Date <i>Dec. 17 / 2002</i>	
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NAME OF SECOND INVENTOR:		<input type="checkbox"/> A petition has been filed for this unsigned inventor	
Given Name (first and middle [if any]) Kazumi		Family Name or Surname Onda	
Inventor's Signature <i>KAZUMI ONDA</i>		Date <i>Dec. 17 / 2002</i>	
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